SN7

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- Inverting Versions of the 'ALS153
- Permit Multiplexing From n Lines to **One Line**
- Perform Parallel-to-Serial Conversion
- Strobe (Enable) Line Provided for Cascading (n Lines to n Lines)
- Typical Power Per Multiplexer Is 16 mW
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

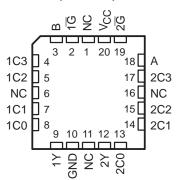
These data selectors/multiplexers contain inverters and drivers to supply fully complementary binary decoding data selection to the AND-OR-invert gates. Separate strobe (\overline{G}) inputs are provided for each of the two 4-line sections.

The SN54ALS352 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS352 is characterized for operation from 0°C to 70°C.

1G [1 16] V _{CC} B [2 15] 2G 1C3 [3 14] A		2 D TOP \		PACKAGE
1C2 4 13 2C3 1C1 5 12 2C2 1C0 6 11 2C1 1Y 7 10 2C0 GND 8 9 2Y	B 1C3 1C2 1C1 1C1 1C0	3 4 5 6 7	15 14 13 12 11	2 G A 2C3 2C2 2C1 2C0

SN54ALS352 ... J PACKAGE

SN54ALS352 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

			FUN		ABLE				
		INP	UTS			OTRODE			
SEL	ECT		DA	TA			OUTPUT Y		
В	Α	C0	C1	C2	C3	,			
Х	Х	Х	Х	Х	Х	Н	Н		
L	L	L	Х	Х	Х	L	н		
L	L	н	Х	Х	х	L	L		
L	н	Х	L	Х	х	L	н		
L	н	Х	Н	Х	х	L	L		
н	L	Х	Х	L	х	L	н		
н	L	Х	Х	Н	х	L	L		
н	н	Х	Х	Х	L	L	н		
н	н	Х	Х	Х	н	L	L		

Select inputs A and B are common to both sections.

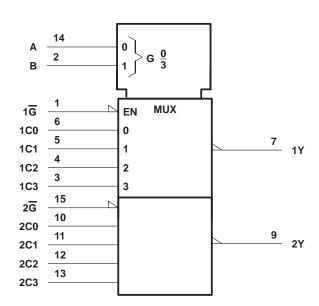
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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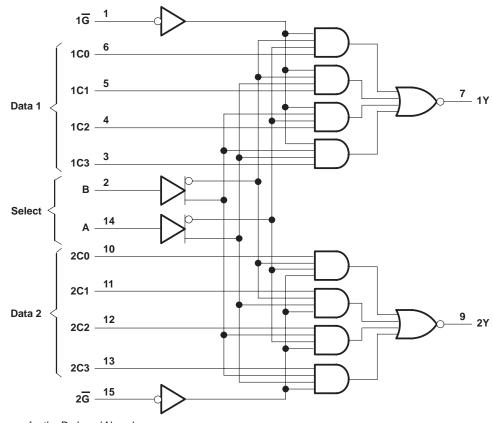
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Input voltage, V _I	7 V
Operating free-air temperature range, T _A : SN54ALS352	-55°C to 125°C
SN74ALS352	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

	SN54ALS352		SN	UNIT				
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
ЮН	High-level output current			-1			-2.6	mA
IOL	Low-level output current			12			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS352			SN74ALS352			UNIT
PARAMETER			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lj = -18 mA			-1.5			-1.5	V
	V _{CC} = 4.5 V to 5.5 V,	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2			
V _{OH} V _{CC} = 4.5 V		I _{OH} = -1 mA	2.4	3.3					V
	VCC = 4.5 V	I _{OH} = -2.6 mA				2.4	3.2		
Ve	V _{CC} = 4.5 V	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	V
VOL		I _{OL} = 24 mA					0.35	0.5	v
lj	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
ЧН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ
Ι _{ΙL}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA
١ _O §	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
ICC	V _{CC} = 5.5 V,	See Note 1		6.5	10		6.5	10	mA

[‡] All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}. NOTE 1: ICC is measured with data and select inputs at 4.5 V and G inputs grounded.



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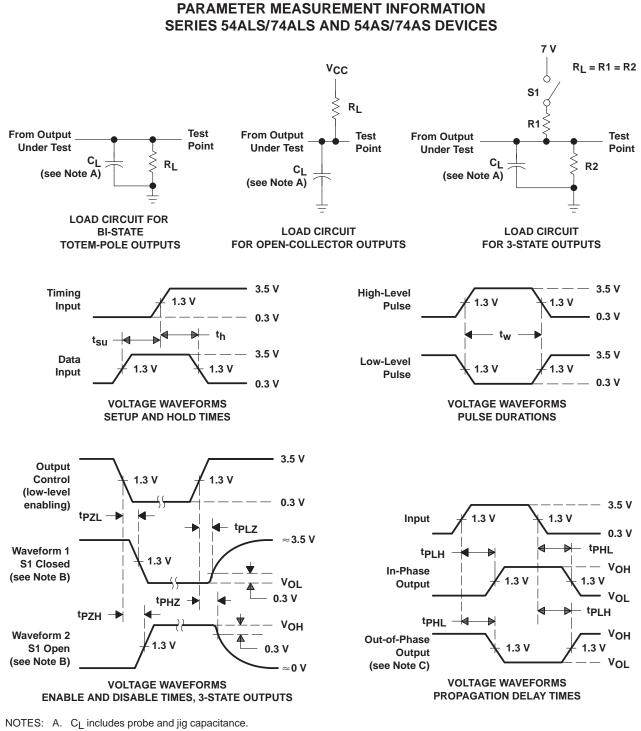
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL Ri	= 50 pl = 500 g		V,	UNIT
			SN54A	LS352	SN74ALS352		
			MIN	MAX	MIN	MAX	
^t PLH	A or B	Y	5	32	5	24	ns
^t PHL			5	24	5	21	115
tPLH	Data (any C)	Y	3	24	3	18	ns
^t PHL			2	15	2	13	115
^t PLH	G	Y	4	26	4	18	ns
^t PHL		1	4	24	4	20	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.
 - The ouputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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